

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Haruo Sunakawa et al.

Docket No.

14463

Serial No.

09/821,411

Filing Date

March 29, 2001

Examiner

S. Mulpuri

Group Art Unit

2812

Invention:

SEP 08 2003

METHOD OF MANUFACTURING A NITROGEN-BASED SEMICONDUCTOR SUBSTRATE
AND A SEMICONDUCTOR ELEMENT BY USING THE SAME

TO THE COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	11 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	1 -	3 =	0 x	\$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
- ☐ A check in the amount of _____ to cover the filing fee is enclosed.
- ☒ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-1013/ssmp
- ☒ Any additional filing fees required under 37 C.F.R. 1.16.
- ☒ Any patent application processing fees under 37 CFR 1.17.

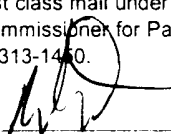


Signature

Dated: Sept. 5, 2003

Richard J. Danyko
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400 Garden City Plaza
Garden city New York 11530
516-742-4343

I certify that this document and fee is being deposited
on 9/5/03 with the U.S. Postal Service as
first class mail under 37 C.F.R. 1.8 and is addressed to the
Commissioner for Patents, P.O. Box 1450, Alexandria, VA
22313-1450.



Signature

Richard J. Danyko

Typed or Printed Name

CC:



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Haruo Sunakawa, et al.

Examiner: S. Mulpuri

Serial No.: 09/821,411

Art Unit: 2812

Filed: March 29, 2001

Docket: 14463

For: METHOD OF MANUFACTURING A
NITROGEN-BASED SEMICONDUCTOR
SUBSTRATE AND A SEMICONDUCTOR
ELEMENT BY USING THE SAME

Dated: September 5, 2003

Commissioner for Patents
Box 1450
Alexandria, VA 22313-1450

RESPONSE PURSUANT TO 37 C.F.R. §1.121

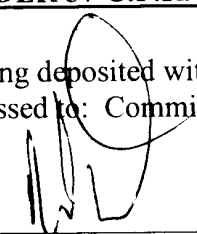
Sir:

In response to the Official Action dated May 8, 2003, and in accordance with the provisions of 37 C.F.R. §1.121, Applicants respectfully submit the following response for entry in the above-identified case.

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Arlington, VA 22313 on September 5, 2003.

Dated: September 5, 2003



Richard J. Danyko